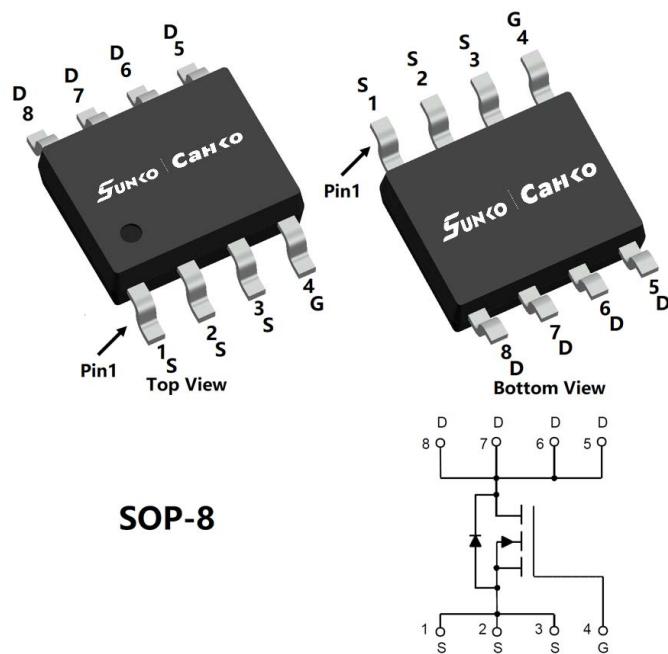


## N-Channel Enhancement Mode Field Effect Transistor



### Product Summary

- $V_{DS}$  30V
- $I_D$  18A
- $R_{DS(ON)}$  (at  $V_{GS} = 10V$ ) <7.0mohm
- $R_{DS(ON)}$  (at  $V_{GS} = 4.5V$ ) <10.0mohm

### General Description

- Trench Power LV MOSFET technology
- High density cell design for low  $R_{DS(ON)}$
- High Speed switching
- Moisture Sensitivity Level 3
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

### Applications

- Battery protection
- Load switch
- Power management

### ■ Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		$V_{DS}$	30	V
Gate-source Voltage		$V_{GS}$	$\pm 20$	V
Drain Current	$T_A=25^\circ\text{C}$ @ Steady State	$I_D$	18	A
	$T_A=70^\circ\text{C}$ @ Steady State		14.5	
Pulsed Drain Current <sup>A</sup>		$I_{DM}$	65	A
Total Power Dissipation @ $T_A=25^\circ\text{C}$		$P_D$	3.0	W
Thermal Resistance Junction-to-Ambient @ Steady State <sup>B</sup>		$R_{\theta JA}$	42	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature Range		$T_J, T_{STG}$	-55~+150	$^\circ\text{C}$

### ■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SCS18N03A	F2	Q18N03.	4000	8000	64000	13" reel

■ Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	30			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}$			1	$\mu\text{A}$
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}= \pm 20\text{V}, V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1	1.5	2.5	V
Static Drain-Source On-Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=18\text{A}$		4.5	7.0	$\text{m}\Omega$
		$V_{\text{GS}}= 4.5\text{V}, I_{\text{D}}=10\text{A}$		6.6	10	
Diode Forward Voltage	$V_{\text{SD}}$	$I_{\text{S}}=12\text{A}, V_{\text{GS}}=0\text{V}$		0.85	1.2	V
Maximum Body-Diode Continuous Current	$I_{\text{S}}$				18	A
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=15\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$		2191		$\text{pF}$
Output Capacitance	$C_{\text{oss}}$			300		
Reverse Transfer Capacitance	$C_{\text{rss}}$			247		
<b>Switching Parameters</b>						
Total Gate Charge	$Q_g$	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=15\text{V}, I_{\text{D}}=20\text{A}$		46.3		$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$			8.8		
Gate-Drain Charge	$Q_{\text{gd}}$			9.2		
Reverse Recovery Charge	$Q_{\text{rr}}$	$I_{\text{F}}=20\text{A}, \frac{dI}{dt}=100\text{A/us}$		1.6		$\text{ns}$
Reverse Recovery Time	$t_{\text{rr}}$			11		
Turn-on Delay Time	$t_{\text{D(on)}}$	$V_{\text{GS}}=10\text{V}, V_{\text{DD}}=15\text{V}, R_{\text{L}}=0.75\Omega, R_{\text{GEN}}=3\Omega$		11		$\text{ns}$
Turn-on Rise Time	$t_r$			80		
Turn-off Delay Time	$t_{\text{D(off)}}$			39		
Turn-off fall Time	$t_f$			92		

A. Pulse Test: Pulse Width  $\leq 300\text{us}$ , Duty cycle  $\leq 2\%$ .B.  $R_{\thetaJA}$  is the sum of the junction-to-lead and lead-to-ambient thermal resistance, where the lead thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\thetaJL}$  is guaranteed by design, while  $R_{\thetaJA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.

## ■ Typical Performance Characteristics

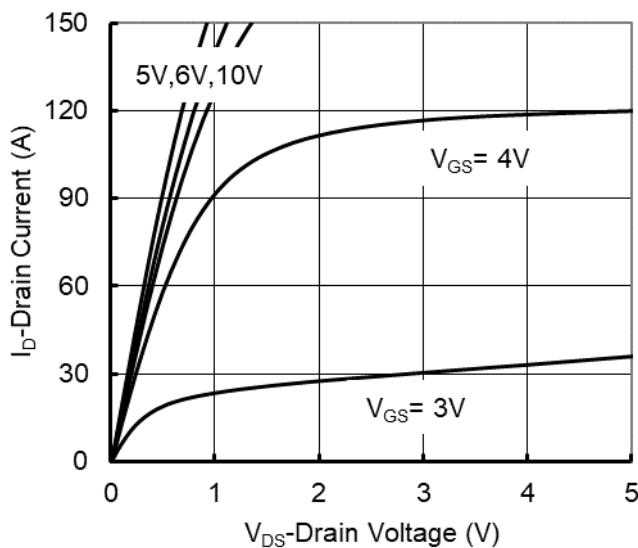


Figure 1. Output Characteristics

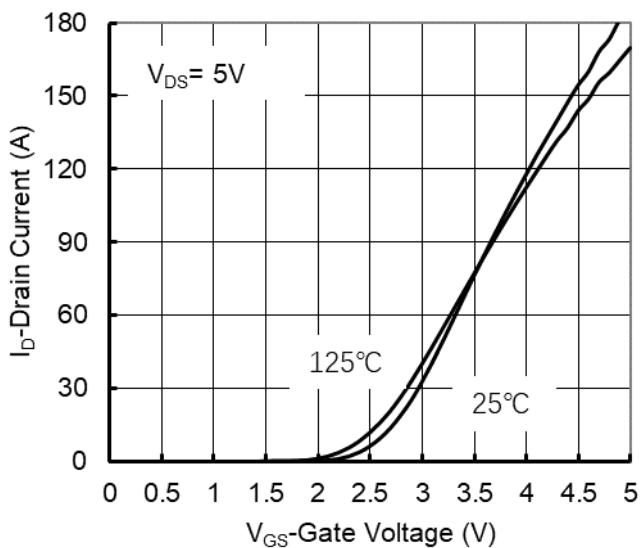


Figure 2. Transfer Characteristics

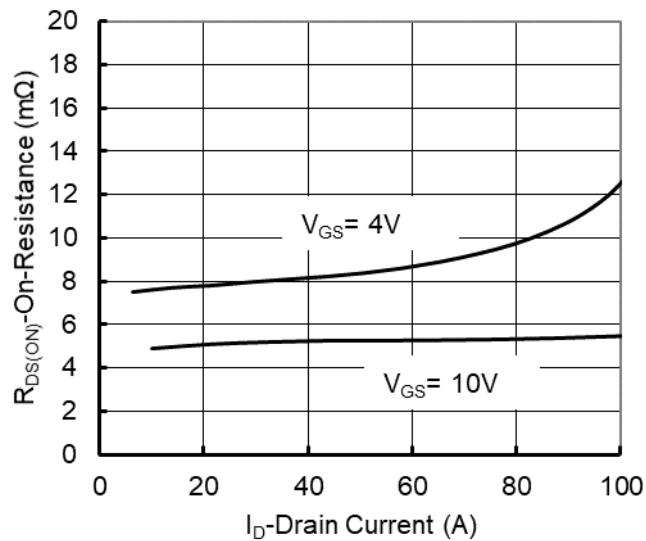


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

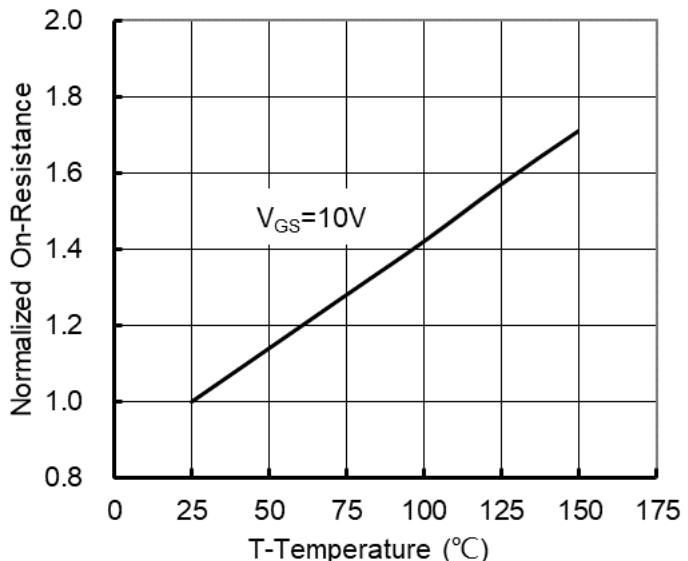


Figure 4. On-Resistance vs. Junction Temperature

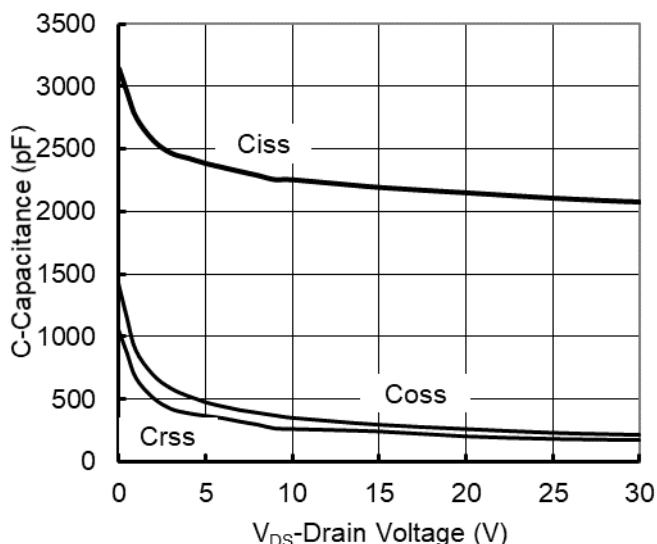


Figure 5. Capacitance Characteristics

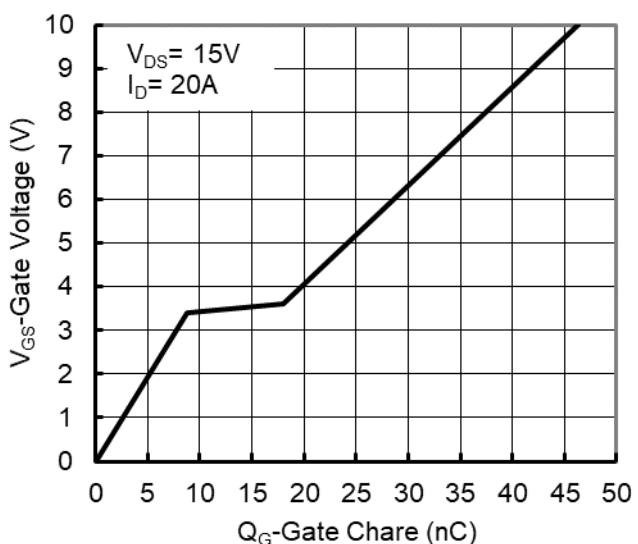
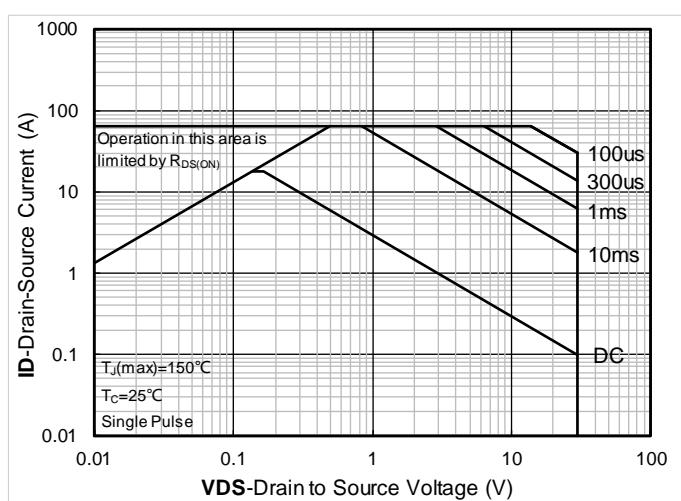
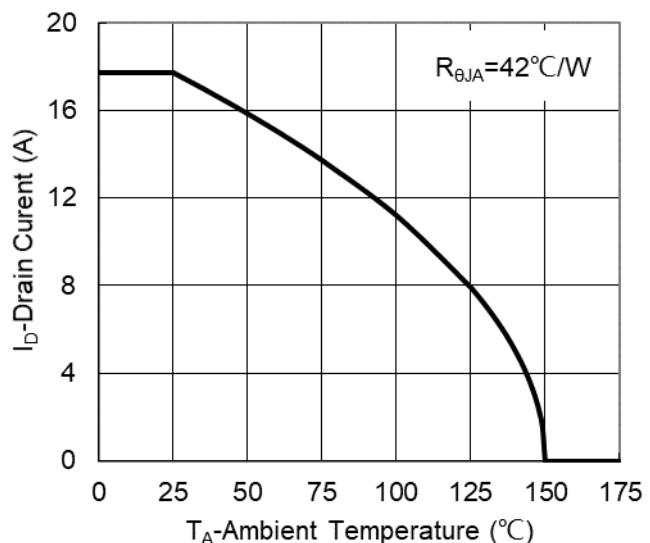


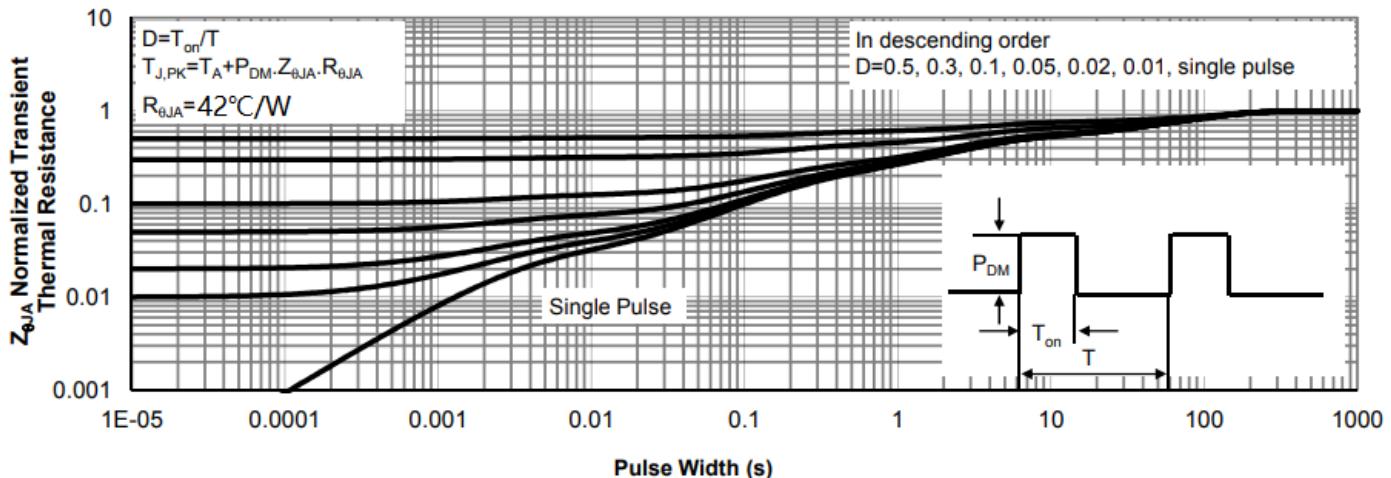
Figure 6. Gate Charge



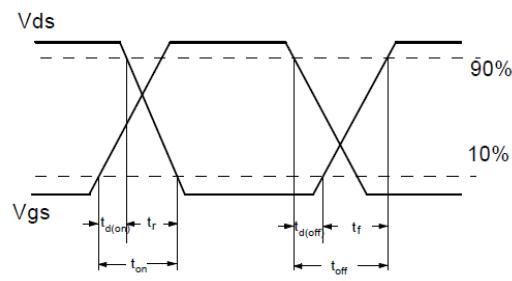
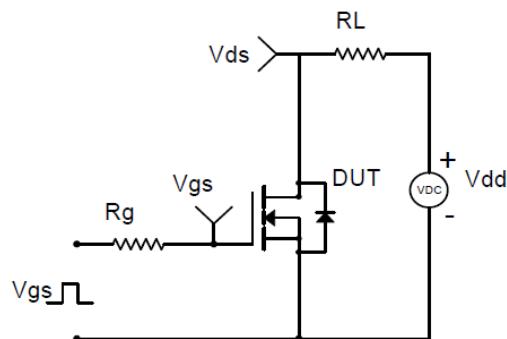
**Figure 7. Safe Operation Area**



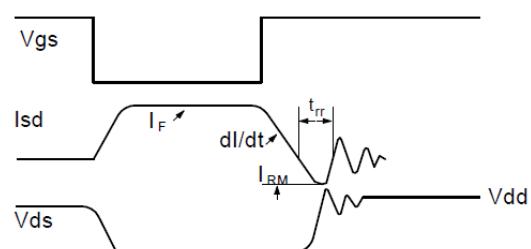
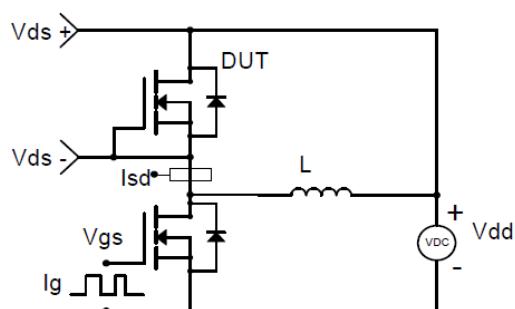
**Figure 8. Maximum Continuous Drain Current vs Ambient Temperature**



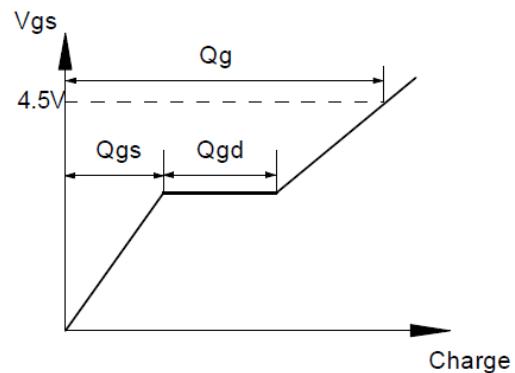
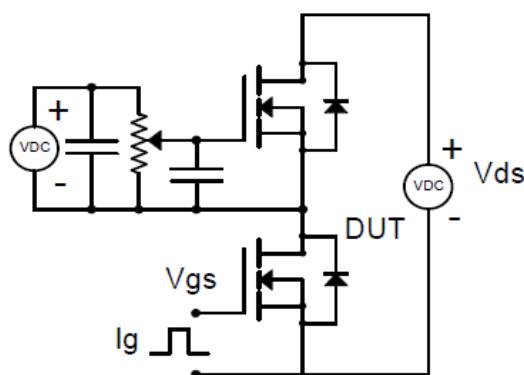
**Figure 9. Normalized Maximum Transient Thermal Impedance**



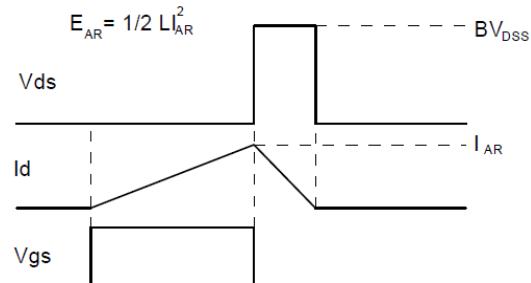
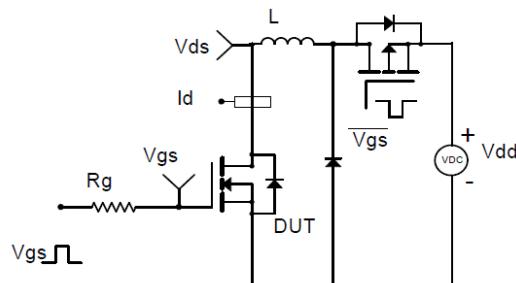
**Resistive Switching Test Circuit & Waveforms**



**Diode Recovery Test Circuit & Waveforms**

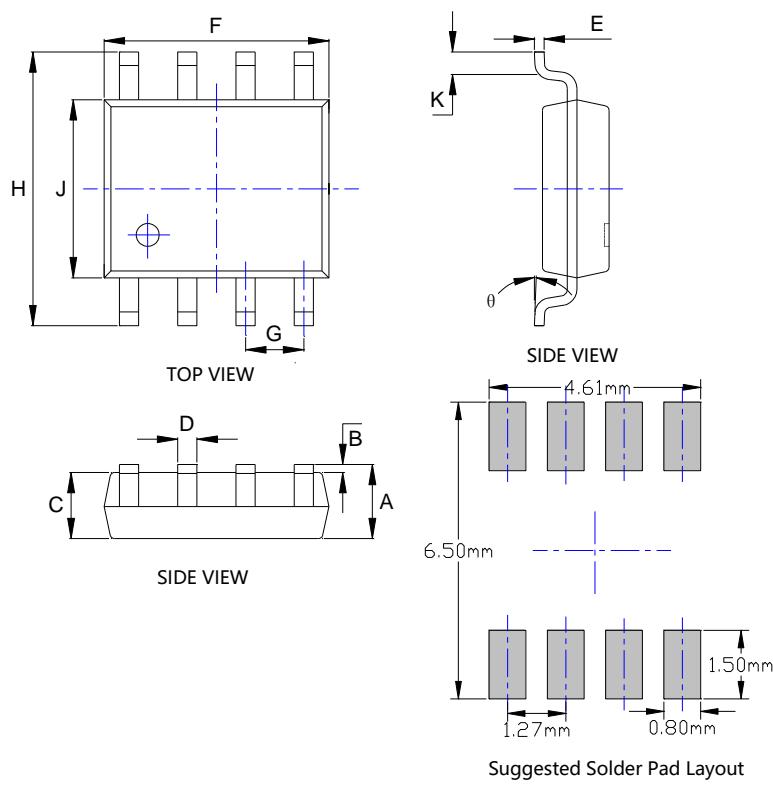


**Gate Charge Test Circuit & Waveform**



**Unclamped Inductive Switching (UIS) Test Circuit & Waveforms**

## ■ SOP-8 Package information



SYMBOL	DIMENSIONS			
	INCHES	Millimeter	MIN.	MAX.
A	0.053	0.069	1.350	1.750
B	0.004	0.010	0.100	0.250
C	0.053	0.061	1.350	1.550
D	0.013	0.020	0.330	0.510
E	0.007	0.010	0.170	0.250
F	0.189	0.197	4.800	5.000
G	0.050BSC		1.270BSC	
H	0.228	0.244	5.800	6.200
J	0.150	0.157	3.800	4.000
K	0.016	0.050	0.400	1.270
θ	0°	8°	0°	8°

### Note:

1. Controlling dimension:in millimeters.
- 2.General tolerance: $+\/-0.05\text{mm}$ .
- 3.The pad layout is for reference purposes only.

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